## Build Up HDI (Standard)

HDI06_2+2(4b)+2_1,00_35_engl

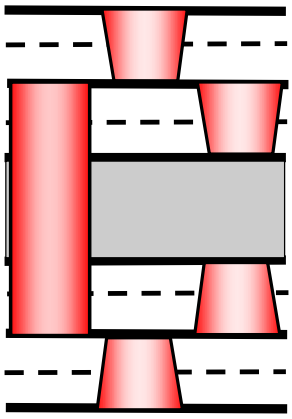
**6 - Layers**

Core: 0,61 mm Cu 35/35 µm

**WE-Articel No.:**

**2 + 2(4B) + 2**

**Customer:**



| layer description | | configuration | Raw-Material | CU | PREPREG | Final Thickness | Customer requirements |
|---|---|---|---|---|---|---|---|
| Customer | WE | | | | | [µm] | [µm] |
| | TOP/VS | | Foil | 12 µm | 1) | 12 | |
| | | | | | 1 x 1080 | **60** | |
| | 2 | | Foil | 12 µm | | **35** | |
| | | | | | 1 x 1080 | **60** | |
| | 3 | | | 35 µm | | **33** | |
| | | | 0,610 mm | | | **610** | |
| | 4 | | | 35 µm | | **33** | |
| | | | | | 1 x 1080 | **60** | |
| | 5 | | Foil | 12 µm | | **35** | |
| | | | | | 1 x 1080 | **60** | |
| | BOT/RS | | Foil | 12 µm | 1) | 12 | |

1) copper thickness outer layers: appr. 55 µm

| | | | | | |
|---|---|---|---|---|---|
| total material thickness: | | | | 1010 | |

Note: Lamination thickness for Prepregs depending on layout characteristics.

| | | | | | | | | |
|---|---|---|---|---|---|---|---|---|
| **final lamination thickness:** | **1,00** | +/- | 0,08 | mm | | | Date: | Engineer: |
| thickness with electro plated Cu: | 1,08 | +/- | 0,11 | mm | | | | |
| total thickness with soldermask | 1,14 | +/- | 0,13 | mm | | | | |
| customer requirement | | +/- | | mm | point: | | | |

| prepared: on | by | checked: on | by | approved: on | by | revision | page: |
|---|---|---|---|---|---|---|---|
| 05.01.2006 | **S. Keller** | 04.05.2006 | M.Kress | 05.01.2006 | R. Schönholz | 00 | 21- |